

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Masahiko KAWASE and Hidenobu KIMOTO. Divisional Application of Parent Serial No.: 09/690,870 Filing Date: Concurrently herewith For: A CHIP-TYPE COMPOSITE ELECTRONIC COMPONENT AND MANUFACTURING METHOD THEREOF	
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PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination on the merits, please amend the above-identified patent application as follows:

IN THE SPECIFICATION:

On page 1, before the first paragraph, please add the following new paragraph:

This application is a Divisional of U.S. Patent Application No. 09/690,870 filed October 17, 2000, currently pending.

IN THE CLAIMS:

Please cancel Claims 1-8 without prejudice or disclaimer of the subject matter contained therein.

REMARKS

Claims 9-20 are pending in this application. By this Amendment, Applicant amends the specification and cancel Claims 1-8.

Applicant respectfully submit that this application is in condition for allowance. Favorable consideration and prompt allowance are respectfully solicited.

The Commissioner is authorized to charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. **50-1353**.

Date: March 6, 2002

Respectfully submitted,



Attorneys for Applicant(s)

Joseph R. Keating
Registration No. 37,368

Christopher A. Bennett
Registration No. 46,710

KEATING & BENNETT LLP
10400 Eaton Place, Suite 312
Fairfax, VA 22030
Telephone: (703) 385-5200